

Outline Dimensions(Unit:mm)











Top view

Side view

Bottom view

Α	В	С	D	Е	
Max	Max	Max	REF	REF	
12.5	12.5	10.0	5.00	7.60	

Electronical Schematic

Suggested Pad layout





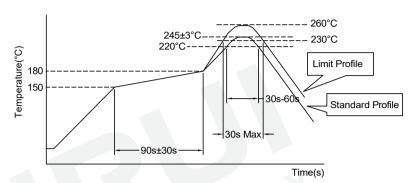
	Н	5.40 REF
1	1	3.00 REF
	J	7.00 REF

Electrical Characteristics(@25°C)

Inductance 100KHz,0.25V	DC Resistor	Isat (A Max)	
8.20uH±30%	0.015Ω Max	L(8.50A)≥75%*L0A	

⁽Temperature rise included)

Recommended Soldering Temperature Graph.



Standard Profile Standard Pr		Standard Profile	
Pre-heating	150~180°C,90s±30s		
Heating	above 220°C,30s-60s	above 240°C,30s Max	
Peak temperature	245°C±3°C	260°C,10s	
Cycle of reflow	2 times	2 times	

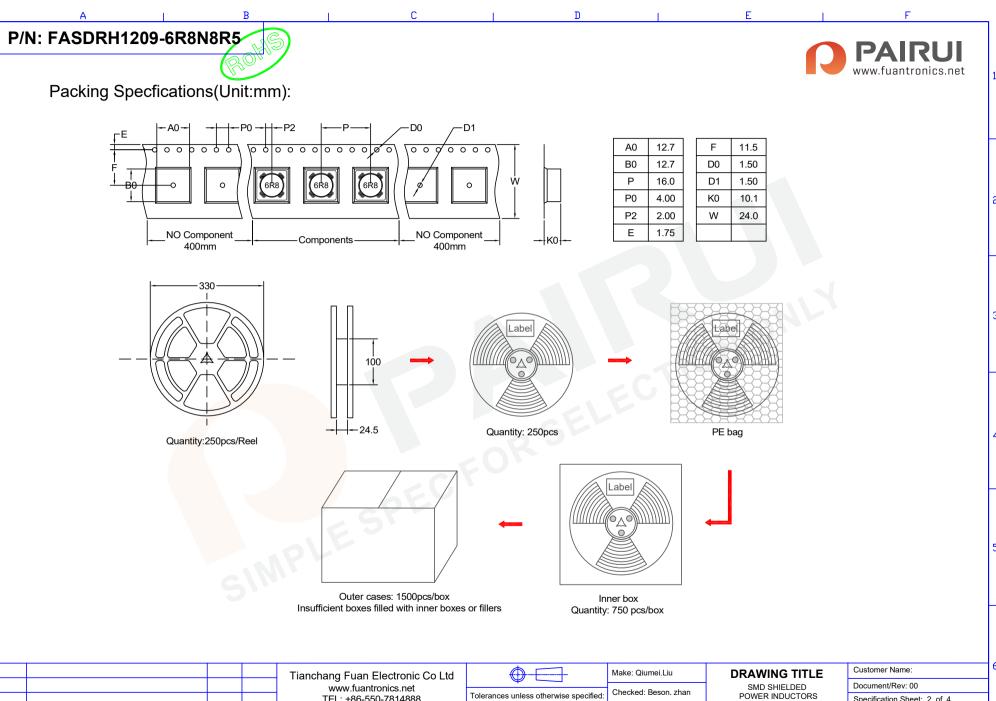
+++0 ·· T		10500
***Operating T	emperature: -40	J°C~+125°C

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				TEL: +86-550-7814888	Tolerances unless otherwise specified: (.X)±0.50 (.XX)±0.25	Checked, Beson, Zhan	POWER INDUCTORS	Specification Sheet: 1 of 4	1
REV	DESCRIPTION	APPD	DATE	FAX:+86-550-7831133	Unit of measurement: mm	Approved: Anson. zhan	Material Number: A341209HS040	Date of Recognition: July./16/2020]

^{***}Storage Temperature: -40°C~+125°C

^{***}Storage Humidity:RH10%~70%

^{***}Weight:Approx 5.01g.

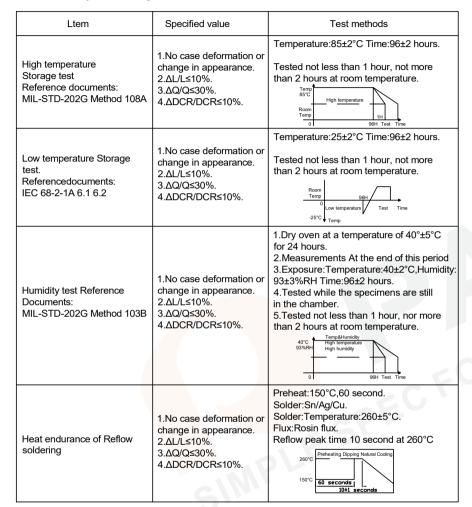


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C D D E I

P/N: FASDRH1209-6R8N8R5

Reliability Testing:





Ltem	Specified value	Test methods
Thermal shock test Reference documents: MIL-STD-202G Method 107G	1.No case deformation or change in appearance. 2.△L/L≤10%. 3.△Q/Q≤30%. 4.△DCR/DCR≤10%. For T:weighe≤28g:15 Min 28g≤weight≤136g:30 Min	First-40°C for T time,next+125°C Ttime as 1 cycle. Go through 20 cycles.
Solderability test Reference documents: MIL-STD-202G Method 208H IPC J-STD-002B	Terminals area must have 95% Min. Solder coverage.	Dip pads in flux then dip in solder pot at 245±5°C for 5 second. Soler:Sn(93.5)Ag(3.5). Flux:Rosin flux.
Vibration test Reference documents: MIL-STD-202G Method 201A	1.No case deformation or change in appearance. 2.ΔL/L≤10%. 3.ΔQ/Q≤30%. 4.ΔDCR/DCR≤10%.	Apply frequency 10~55Hz. 0.75mm amplitude in each of perpendicular direction for 2 hours. (total 6 hours). Frequency 10~55Hz. 0.75mm amplitude in each of perpendicular direction for 2 hours. (total 6 hours).
Drop test Reference documents: MIL-STD-202G Method 203G	1.No case deformation or change in appearance. 2.∆L/L≤10%. 3.∆Q/Q≤30%. 4.∆DCR/DCR≤10%. For T:weighe≤28g:15 Min 28g≤weight≤136g:30 Min	Packaged & Drop down from 1m with 981m/s2(100G)attitude in 1 angle 1 ridges & 2 surfaces orientations.
Terminal strength push test Reference documents: JIS C 5321:1997	Pulling test: DEFINE:A:sectional area of terminal A≤8(Sq M) Force≥5N time:30sec 8(Sq M) <a≤20(sq 20(sq="" bending="" force≥10n="" force≥20n="" m)="" m)<a="" not="" off<="" on="" pcb,after="" products="" pull="" pulling="" should="" soldering="" td="" terminal="" test,="" test:="" testand="" the="" time:10sec=""><td>Bend the testing PCB at middle point, the deflection shall be 2mm Pulling lest R0.5 Bending test</td></a≤20(sq>	Bend the testing PCB at middle point, the deflection shall be 2mm Pulling lest R0.5 Bending test

REV	DESCRIPTION	APPD	DATE

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Tolerances unless	otherwise specific
(.X)±0.50	(.XX)±0.25
Unit of meas	surement: mm

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	Approved: Anson. zhan					

DRAWING TITLE
SMD SHIELDED POWER INDUCTORS

Material Number: A341209HS040

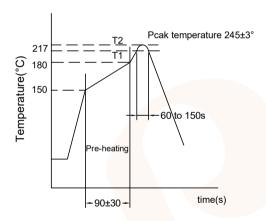
	Customer Name:
	Document/Rev: 00
	Specification Sheet: 3 of 4
	Date of Recognition: July./16/2020

P/N: FASDRH1209-6R8N8R5



Ltem	Specified value	Test methods
Resistance to solvent test Reference documents: IEC 68-2-45:1993	No case deformation or change in appearance,or obliteration of marking	To dip parts into IPA solvent for 5±0.5Min, then drying them atroom temp for 5 Min,at last,to brushing making 10 times.
Electronic characteristic test of major products	Refer to catalogue of specific products	Refer to catalogue of specific products
Overload test Reference documents:	1.During the test no smoke,no peculiar,smell, no fire	Apply twice as rated current for 5 minutes.

Recommended solderability temperature profile:



Use rosin-based flux Don't use high acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value). Use lead-free solder, use Sn-3.0Ag-0.5Cu solder Standard thickness of solder paste:0.12-0.15mm

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DRAWING TITLE
SMD SHIELDED
POWER INDUCTORS

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